XS1-L6A-64-TQ48 Datasheet



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It is our intention to provide you with accurate and comprehensive documentation for the hardware and software components used in this product. To subscribe to receive updates, visit http://www.xmos.com/.

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1 xCORE Multicore Microcontrollers

The XS1-L Series is a comprehensive range of 32-bit multicore microcontrollers that brings the low latency and timing determinism of the xCORE architecture to mainstream embedded applications. Unlike conventional microcontrollers, xCORE multicore microcontrollers execute multiple real-time tasks simultaneously. Devices consist of one or more xCORE tiles, each containing between four and eight independent xCORE logical processors. Each logical core can execute computational code, advanced DSP code, control software (including logic decisions and executing a state machine) or software that handles I/O.

Because xCORE multicore microcontrollers are completely deterministic, you can write software to implement functions that traditionally require dedicated hardware. You can simulate your program like hardware, and perform static timing analysis using the xTIMEcomposer development tools.

The devices include scheduling hardware that performs functions similar to those of an RTOS; and hardware that connects the cores directly to I/O ports, ensuring not only fast processing but extremely low latency. The use of interrupts is eliminated, ensuring deterministic operation.

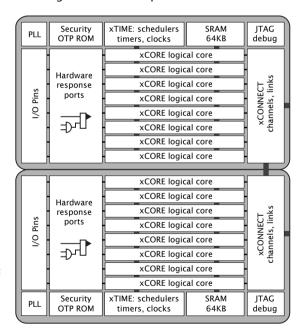


Figure 1: XS1-L Series: 4-16 core devices

XS1-L devices are available in a range of resource densities, package, performance and temperature grades depending on your needs. XS1-L devices range from 4-16 logical cores divided between one or two xCORE tiles, providing 400-1000 MIPS, up to 84 GPIO, and 64Kbytes or 128Kbytes of SRAM.



1.1 xSOFTip

xCORE devices are backed with tested and proven IP blocks from the xSOFTip library, which allow you to quickly add interface and processor functionality such as Ethernet, PWM, graphics driver, and audio EQ to your xCORE device.

xSOFTip blocks are written in high level languages and use xCORE resources to implement given function. This means xSOFTip is software and brings the associated benefits of easy maintenance and fast compilation time, while being accessible to anyone with embedded C skills.

The graphical xSOFTip Explorer tool lets you browse available xSOFTip blocks from our library, understand the resource usage, configure the blocks to your specification, and estimates the right device for your design. It is included in xTIME-composer Studio or available as a standalone tool from xmos.com/downloads.

1.2 xTIMEcomposer Studio

Designing with XS1-L devices is simple thanks to the xTIMEcomposer Studio development environment, which includes a highly efficient compiler, debugger and device programming tools. Because xCORE devices operate deterministically, they can be simulated like hardware within the development tools: uniquely in the embedded world, xTIMEcomposer Studio therefore includes a static timing analyzer, cycle-accurate simulator, and high-speed in-circuit instrumentation.

xTIMEcomposer can also be used to load the executable file onto the device and debug it over JTAG, programmed it into flash memory on the board, or write it to OTP memory on the device. The tools can also encrypt the flash image and write the decrpytion key securely to OTP memory.

xTIMEcomposer can be driven from either a graphical development environment that will be familiar to any C programmer, or the command line. They are supported on Windows, Linux and MacOS X and available at no cost from xmos.com/downloads.

Information on using the tools is provided in a separate user guide, X3766.



2 XS1-L6A-64-TQ48 Features

► Six-Core Multicore Microcontroller with Advanced Multi-Core RISC Architecture

- Up to 500 MIPS shared between up to 6 real-time logical cores
- Each logical core has:
 - Guaranteed throughput of between 1/4 and 1/6 of tile MIPS
 - 16x32bit dedicated registers
- 159 high-density 16/32-bit instructions
 - All have single clock-cycle execution (except for divide)
 - 32x32-64-bit MAC instructions for DSP, arithmetic and user-definable cryptographic functions

► Programmable I/O

- 28 general-purpose I/O pins, configurable as input or output
 - Up to 16 x 1bit port, 2 x 4bit port, 1 x 8bit port
 - 2 xCONNECT links
- Port sampling rates of up to 60 MHz with respect to an external clock
- 32 channel ends for communication with other cores, on or off-chip

Memory

- 64KB internal single-cycle SRAM for code and data storage
- 8KB internal OTP for application boot code

▶ Hardware resources

- 6 clock blocks
- 10 timers
- 4 locks

▶ JTAG Module for On-Chip Debug

Security Features

- Programming lock disables debug and prevents read-back of memory contents
- AES bootloader ensures secrecy of IP held on external flash memory

► Ambient Temperature Range

- Commercial qualification: 0°C to 70°C
- Industrial qualification: -40 °C to 85 °C

► Speed Grade

- 5: 500 MIPS
- 4: 400 MIPS

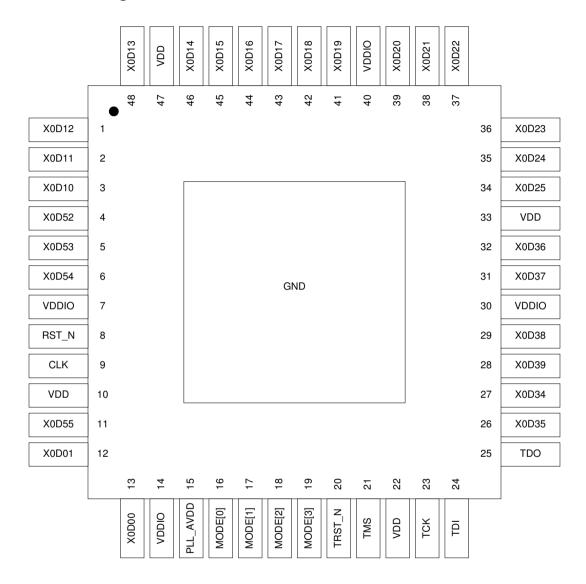
▶ Power Consumption

- Active Mode
 - 200 mA at 500 MHz (typical)
 - 160 mA at 400 MHz (typical)
- Standby Mode
 - $-14 \,\mathrm{mA}$

▶ 48-pin TQ48 package 0.5 mm pitch



3 Pin Configuration





4 Signal Description

| Module | Signal | Function | Туре | | Properties |
|--------|----------------|-------------------------------------------------------------------------------------------|--------|-----|----------------------------------|
| | PU=Pu | ll Up, PD=Pull Down, ST=Schmitt Trigger Inp | | | |
| | | R _S =Required for SPI boot (§7), R _U =R | | | ed devices (§E) |
| | GND | Digital ground | GND | _ | |
| | PLL_AVDD | Analog PLL power | PWR | _ | |
| Power | RST_N | Global reset input | Input | Low | PU, ST |
| | VDD | Digital tile power | PWR | _ | |
| | VDDIO | Digital I/O power | PWR | _ | |
| Clocks | CLK | PLL reference clock | Input | _ | PD, ST |
| CIOCKS | MODE[3:0] | Boot mode select | Input | _ | PU, ST |
| | TCK | Test clock | Input | _ | PU, ST |
| | TDI | Test data input | Input | _ | PU, ST |
| JTAG | TDO | Test data output | Output | _ | PD, OT |
| | TMS | Test mode select | Input | _ | PU, ST |
| | TRST_N | Test reset input | Input | Low | PU, ST |
| | X0D00 | P1A ⁰ | 1/0 | _ | PD _S , R _S |
| | X0D01 | P1B ⁰ | I/O | _ | PD _S , R _S |
| | X0D10 | P1C ⁰ | I/O | _ | PD _S , R _S |
| | X0D11 | P1D ⁰ | I/O | _ | PD _S , R _S |
| | X0D12 | P1E ⁰ | I/O | _ | PD _S , R _U |
| | X0D13 | XLB ⁴ _{out} P1F ⁰ | 1/0 | _ | PD _S , R _U |
| | X0D14 | XLB _{out} P4C ⁰ P8B ⁰ P16A ⁸ P32A ²⁸ | 1/0 | _ | PDs, Ru |
| | X0D15 | XLB _{out} P4C ¹ P8B ¹ P16A ⁹ P32A ²⁹ | 1/0 | _ | PD _S , R _U |
| | X0D16 | XLB ¹ _{out} P4D ⁰ P8B ² P16A ¹⁰ | I/O | _ | PD _S , R _U |
| | X0D17 | XLB ⁰ _{out} P4D ¹ P8B ³ P16A ¹¹ | 1/0 | _ | PD _S , R _U |
| | X0D18 | XLB ⁰ P4D ² P8B ⁴ P16A ¹² | 1/0 | _ | PD _S , R _U |
| | X0D19 | XLB ¹ _{in} P4D ³ P8B ⁵ P16A ¹³ | 1/0 | _ | PD _S , R _U |
| | X0D20 | XLB ² P4C ² P8B ⁶ P16A ¹⁴ P32A ³⁰ | 1/0 | _ | PD _S , R _U |
| | X0D21 | XLB _{in} P4C ³ P8B ⁷ P16A ¹⁵ P32A ³¹ | 1/0 | _ | PDs, Ru |
| I/O | X0D22 | XLB ⁴ _{in} P1G ⁰ | 1/0 | _ | PD _S , R _U |
| | X0D23 | P1H ⁰ | 1/0 | _ | PD _S , R _U |
| | X0D24 | P1I ⁰ | 1/0 | _ | PDs |
| | X0D25 | P1I ⁰ | 1/0 | _ | PDs |
| | X0D34 | P1K ⁰ | 1/0 | _ | PDs |
| | X0D35 | P1L ⁰ | 1/0 | _ | PDs |
| | X0D36 | P1M ⁰ P8D ⁰ P16B ⁸ | 1/0 | _ | PDs |
| | X0D37 | P1N ⁰ P8D ¹ P16B ⁹ | 1/0 | _ | PD _S , R _U |
| | X0D38 | P1O ⁰ P8D ² P16B ¹⁰ | 1/0 | _ | PD _S , R _U |
| | X0D30 X0D39 | P1P ⁰ P8D ³ P16B ¹¹ | 1/0 | _ | PD _S , R _U |
| | X0D53 | XLC _{out} P32A ³ | 1/0 | _ | PD _S , R ₀ |
| | X0D52 X0D53 | XLC _{out} P32A P32A ⁴ | 1/0 | | PDs |
| | X0D53 | XLC _{in} P32A P32A ⁵ | 1/0 | | PDs |
| | X0D54 X0D55 | XLC _{in} P32A ⁶ | 1/0 | | PDs |



5 Product Overview

The XMOS XS1-L6A-64-TQ48 is a powerful device that provides a simple design process and highly-flexible solution to many applications. The device consists of a single xCORE Tile, which comprises a flexible multicore microcontroller with tightly integrated I/O and on-chip memory. The processor runs mutiple tasks simultaneously using logical cores, each of which is guaranteed a slice of processing power and can execute computational code, control software and I/O interfaces. Logical cores use channels to exchange data within a tile or across tiles. Multiple devices can be deployed and connected using an integrated switching network, enabling more resources to be added to a design. The I/O pins are driven using intelligent ports that can serialize data, interpret strobe signals and wait for scheduled times or events, making the device ideal for real-time control applications.

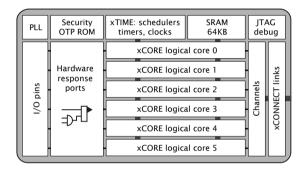


Figure 2: Block Diagram

The device can be configured using a set of software components that are rapidly customized and composed. XMOS provides source code libraries for many standard components. The device can be programmed using high-level languages such as C/C++ and XMOS-originated extensions to C, called XC, that simplify the control over concurrency. I/O and time.

The XMOS toolchain includes compilers, a simulator, debugger and static timing analyzer. The combination of real-time software, a compiler and timing analyzer enables the programmer to close timings on components of the design without a detailed understanding of the hardware characteristics.

5.1 Logical cores, Synchronizers and Locks

The tile has up to 6 active logical cores, which issue instructions down a shared four-stage pipeline. Instructions from the active cores are issued round-robin. If up to 4 logical cores are active, each core is allocated a quarter of the processing cycles. If more than four logical cores are active, each core is allocated at least 1/n cycles (for n cores). Figure 3 shows the guaranteed core performance depending on the number of cores used.

There is no way that the performance of a logical core can be reduced below these predicted levels. Because cores may be delayed on I/O, however, their unused processing cycles can be taken by other cores. This means that for more than



Figure 3: Logical core performance

| Speed Grade, MIPS, and frequency | М | inimun | n MIPS | per cor | e (for <i>r</i> | core | s) | |
|----------------------------------|-----|--------|--------|---------|-----------------|------|----|--|
| | 1 | 2 | 3 | 4 | 5 | 6 | | |
| 4: 400 MIPS, 400 MHz | 100 | 100 | 100 | 100 | 80 | 67 | | |
| 5: 500 MIPS, 500 MHz | 125 | 125 | 125 | 125 | 100 | 83 | | |

four logical cores, the performance of each core is often higher than the predicted minimum.

Synchronizers are provided for fast synchronization in a group of logical cores. In a single instruction a logical core can block until all other logical cores in a group have reached the synchronizer. Locks are provided for fast mutual exclusion. A logical core can acquire or release a lock in a single instruction.

5.2 Channel Ends. Links and Switch

Logical cores communicate using point-to-point connections formed between two channel ends. Between tiles, channel communications are implemented over xConnect Links and routed through switches. The links operate in either 2 wires per direction or 5 wires per direction mode, depending on the amount of bandwidth required. Circuit switched, streaming and packet switched data can both be supported efficiently. Streams provide the fastest possible data rates between xCORE Tiles (up to 250 MBit/s), but each stream requires a single link to be reserved between switches on two tiles. All packet communications can be multiplexed onto a single link.

Information on the supported routing topologies that can be used to connect multiple devices together can be found in the XS1-L Link Performance and Design Guide, X2999.

5.3 Ports and Clock Blocks

Ports provide an interface between the logical cores and I/O pins. The XS1-L6A-64-TQ48 includes a combination of 1bit, 4bit and 8bit ports. In addition the wider ports are partially or fully bonded out making the connected pins available for I/O or xCONNECT links. All pins of a port provide either output or input. Signals in different directions cannot be mapped onto the same port.

The operation of each port can be synchronized to a clock block. A clock block can be connected to an external clock input, or it can be run from the divided reference clock. A clock block can also output its signal to a pin. On reset, each port is connected to clock block 0, which runs from the xCORE Tile reference clock.

The ports and links are multiplexed, allowing the pins to be configured for use by ports of different widths or links. If an xConnect Link is enabled, the pins of the underlying ports are disabled. If a port is enabled, it overrules ports with higher widths that share the same pins. The pins on the wider port that are not shared remain available for use when the narrower port is enabled. Ports always operate at their specified width, even if they share pins with another port.



5.4 Timers

Timers are 32-bit counters that are relative to the xCORE Tile reference clock. A timer is defined to tick every 10 ns. This value is derived from the reference clock, which is configured to tick at 100 MHz by default.

6 PLL

The PLL creates a high-speed clock that is used for the switch, tile, and reference clock. The PLL multiplication value is selected through the two MODE pins, and can be changed by software to speed up the tile or use less power. The MODE pins are set as shown in Figure 4:

Figure 4: PLL multiplier values and MODE pins

| Oscillator | MC | DDE | Tile | PLL Ratio | PLL | setting | gs |
|------------|----|-----|----------------|-----------|-----|---------|----|
| Frequency | 1 | 0 | Frequency | | OD | F | R |
| 5-13 MHz | 0 | 0 | 130-399.75 MHz | 30.75 | 1 | 122 | 0 |
| 13-20 MHz | 1 | 1 | 260-400.00 MHz | 20 | 2 | 119 | 0 |
| 20-48 MHz | 1 | 0 | 167-400.00 MHz | 8.33 | 2 | 49 | 0 |
| 48-100 MHz | 0 | 1 | 196-400.00 MHz | 4 | 2 | 23 | 0 |

Figure 4 also lists the values of *OD*, *F* and *R*, which are the registers that define the ratio of the tile frequency to the oscillator frequency:

$$F_{core} = F_{osc} \times \frac{F+1}{2} \times \frac{1}{R+1} \times \frac{1}{OD+1}$$

OD, F and R must be chosen so that $0 \le R \le 63$, $0 \le F \le 4095$, $0 \le OD \le 7$, and $260MHz \le F_{osc} \times \frac{F+1}{2} \times \frac{1}{R+1} \le 1.3GHz$. The OD, F, and R values can be modified by writing to the digital node PLL configuration register.

The MODE pins must be held at a static value until the third rising edge of the system clock following the deassertion of the system reset.

For 500 MHz parts, once booted, the PLL must be reprogrammed to provide this tile frequency. The XMOS tools perform this operation by default.

Further details on configuring the clock can be found in the XS1-L Clock Frequency Control document. X1433.

7 Boot Procedure

The device is kept in reset by driving RST_N low. When in reset, all GPIO pins are high impedance. When the device is taken out of reset by releasing RST_N the processor starts its internal reset process. After 15-150 μ s (depending on the input clock), all GPIO pins have their internal pull-resistor enabled, and the processor boots at a clock speed that depends on MODE0 and MODE1.



The xCORE Tile boot procedure is illustrated in Figure 5. In normal usage, MODE[3:2] controls the boot source according to the table in Figure 6. If bit 5 of the security register (see §8.1) is set, the device boots from OTP.

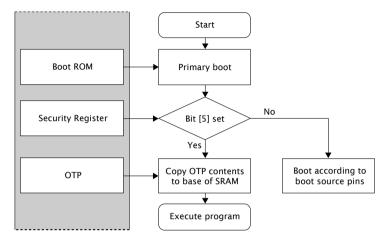


Figure 5: Boot procedure

Figure 6: Boot source pins

| MODE[3] | MODE[2] | Boot Source |
|---------|---------|------------------------------------------|
| 0 | 0 | None: Device waits to be booted via JTAG |
| 0 | 1 | Reserved |
| 1 | 0 | xConnect Link B |
| 1 | 1 | SPI |

The boot image has the following format:

- ▶ A 32-bit program size *s* in words.
- ▶ Program consisting of $s \times 4$ bytes.
- A 32-bit CRC, or the value 0x0D15AB1E to indicate that no CRC check should be performed.

The program size and CRC are stored least significant byte first. The program is loaded into the lowest memory address of RAM, and the program is started from that address. The CRC is calculated over the byte stream represented by the program size and the program itself. The polynomial used is 0xEDB88320 (IEEE 802.3); the CRC register is initialized with 0xFFFFFFFF and the residue is inverted to produce the CRC.

7.1 Boot from SPI

If set to boot from SPI, the processor enables the four pins specified in Figure 7, and drives the SPI clock at 2.5 MHz (assuming a 400 MHz core clock). A READ command is issued with a 24-bit address 0×000000 . The clock polarity and phase are 0 / 0.



| Pin | Signal | Description |
|-------|--------|----------------------------|
| X0D00 | MISO | Master In Slave Out (Data) |
| X0D01 | SS | Slave Select |
| X0D10 | SCLK | Clock |
| X0D11 | MOSI | Master Out Slave In (Data) |

Figure 7: SPI pins

The xCORE Tile expects each byte to be transferred with the *least-significant bit first*. Programmers who write bytes into an SPI interface using the most significant bit first may have to reverse the bits in each byte of the image stored in the SPI device.

If a large boot image is to be read in, it is faster to first load a small boot-loader that reads the large image using a faster SPI clock, for example 50 MHz or as fast as the flash device supports.

The pins used for SPI boot are hardcoded in the boot ROM and cannot be changed. If required, an SPI boot program can be burned into OTP that uses different pins.

7.2 Boot from xConnect Link

If set to boot from an xConnect Link, the processor enables Link B around 200 ns after the boot process starts. Enabling the Link switches off the pull-down on resistors X0D16..X0D19, drives X0D16 and X0D17 low (the initial state for the Link), and monitors pins X0D18 and X0D19 for boot-traffic. X0D18 and X0D19 must be low at this stage. If the internal pull-down is too weak to drain any residual charge, external pull-downs of 10K may be required on those pins.

The boot-rom on the core will then:

- 1. Allocate channel-end 0.
- 2. Input a word on channel-end 0. It will use this word as a channel to acknowledge the boot. Provide the null-channel-end 0×0000 FF02 if no acknowledgment is required.
- 3. Input the boot image specified above, including the CRC.
- 4. Input an END control token.
- 5. Output an END control token to the channel-end received in step 2.
- 6. Free channel-end 0.
- 7. Jump to the loaded code.

7.3 Boot from OTP

If an xCORE tile is set to use secure boot (see Figure 5), the boot image is read from address 0 of the OTP memory in the tile's security module.



This feature can be used to implement a secure bootloader which loads an encrypted image from external flash, decrypts and CRC checks it with the processor, and discontinues the boot process if the decryption or CRC check fails. XMOS provides a default secure bootloader that can be written to the OTP along with secret decryption keys.

Each tile has its own individual OTP memory, and hence some tiles can be booted from OTP while others are booted from SPI or the channel interface. This enables systems to be partially programmed, dedicating one or more tiles to perform a particular function, leaving the other tiles user-programmable.

7.4 Security register

The security register enables security features on the xCORE tile. The features shown in Figure 8 provide a strong level of protection and are sufficient for providing strong IP security.

| Feature | Bit | Description |
|---------------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Disable JTAG | 0 | The JTAG interface is disabled, making it impossible for the tile state or memory content to be accessed via the JTAG interface. |
| Disable Link access | 1 | Other tiles are forbidden access to the processor state via the system switch. Disabling both JTAG and Link access transforms an xCORE Tile into a "secure island" with other tiles free for non-secure user application code. |
| Secure Boot | 5 | The xCORE Tile is forced to boot from address 0 of the OTP, allowing the xCORE Tile boot ROM to be bypassed (see §7). |
| Redundant rows | 7 | Enables redundant rows in OTP. |
| Sector Lock 0 | 8 | Disable programming of OTP sector 0. |
| Sector Lock 1 | 9 | Disable programming of OTP sector 1. |
| Sector Lock 2 | 10 | Disable programming of OTP sector 2. |
| Sector Lock 3 | 11 | Disable programming of OTP sector 3. |
| OTP Master Lock | 12 | Disable OTP programming completely: disables updates to all sectors and security register. |
| Disable JTAG-OTP | 13 | Disable all (read & write) access from the JTAG interface to this OTP. |
| | 2115 | General purpose software accessable security register available to end-users. |
| | 3122 | General purpose user programmable JTAG UserID code extension. |

Figure 8: Security register features



8 Memory

8.1 OTP

The xCORE Tile integrates 8 KB one-time programmable (OTP) memory along with a security register that configures system wide security features. The OTP holds data in four sectors each containing 512 rows of 32 bits which can be used to implement secure bootloaders and store encryption keys. Data for the security register is loaded from the OTP on power up. All additional data in OTP is copied from the OTP to SRAM and executed first on the processor.

The OTP memory is programmed using three special I/O ports: the OTP address port is a 16-bit port with resource ID 0x100200, the OTP data is written via a 32-bit port with resource ID 0x200100, and the OTP control is on a 16-bit port with ID 0x100300. Programming is performed through libotp and xburn.

8.2 SRAM

The xCORE Tile integrates a single 64 KB SRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or 32-bit. Byte (8-bit), half-word (16-bit) or word (32-bit) accesses are supported and are executed within one tile clock cycle. There is no dedicated external memory interface, although data memory can be expanded through appropriate use of the ports.

9 JTAG

The JTAG module can be used for loading programs, boundary scan testing, incircuit source-level debugging and programming the OTP memory.

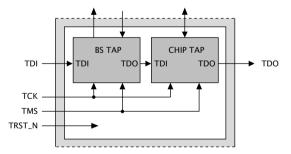


Figure 9: JTAG chain structure

The JTAG chain structure is illustrated in Figure 9. Directly after reset, two TAP controllers are present in the JTAG chain: the boundary scan TAP and the chip TAP. The boundary scan TAP is a standard 1149.1 compliant TAP that can be used for boundary scan of the I/O pins. The chip TAP provides access into the xCORE Tile, switch and OTP for loading code and debugging.



The TRST_N pin must be asserted low during and after power up for 100 ns. If JTAG is not required, the TRST_N pin can be tied to ground to hold the JTAG module in reset.

The JTAG device identification register can be read by using the IDCODE instruction. Its contents are specified in Figure 10.

Figure 10: IDCODE return value

| Bi | t31 | | | | | | | | | | | D | evice | e Ide | ntifi | catio | n R | egist | er | | | | | | | | | | | Е | it0 |
|----|-----|-------|---|---|---|---|---|---|---|----|------|-----|-------|-------|-------|-------|-----|-------|----|---|---|-----|-----|------|------|-------|-------|---|---|---|-----|
| | Vei | rsion | | | | | | | | Pa | rt N | umb | er | | | | | | | | | - 1 | Man | ufac | ture | r Ide | ntity | / | | | 1 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 1 |
| | | 0 | | | (|) | | | (|) | | | (|) | | | - : | 2 | | | 6 | 5 | | | - 3 | 3 | | | | 3 | |

The JTAG usercode register can be read by using the USERCODE instruction. Its contents are specified in Figure 11. The OTP User ID field is read from bits [22:31] of the security register, see §8.1 (all zero on unprogrammed devices).

Figure 11: USERCODE return value

| В | 3it3 | 1 | | | | | | | | | | | | - 1 | User | code | Reg | giste | r | | | | | | | | | | | | В | it0 |
|---|------|---|---|---|------|------|----|---|---|---|---|-----|-----|-----|------|------|-----|-------|---|---|---|-------|------|-------|------|---|---|---|---|---|---|-----|
| | | | | 0 | TP U | lser | ID | | | | | Unu | sed | | | | | | | | | Silio | on I | Revis | sion | | | | | | | |
| C |) | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | (|) | | | (| 0 | | | (| 0 | | | - : | 2 | | | 8 | 8 | | | (|) | | | (|) | | | (|) | |

10 Board Integration

The device has the following power supply pins:

- ▶ VDD pins for the xCORE Tile
- ▶ VDDIO pins for the I/O lines
- ▶ PLL_AVDD pins for the PLL

Several pins of each type are provided to minimize the effect of inductance within the package, all of which must be connected. The power supplies must be brought up monotonically and input voltages must not exceed specification at any time.

The VDD supply must ramp from 0 V to its final value within 10 ms to ensure correct startup.

The VDDIO supply must ramp to its final value before VDD reaches 0.4 V.

The PLL_AVDD supply should be separated from the other noisier supplies on the board. The PLL requires a very clean power supply, and a low pass filter (for example, a $4.7\,\Omega$ resistor and $100\,\text{nF}$ multi-layer ceramic capacitor) is recommended on this pin.

The following ground pins are provided:

GND for all supplies

All ground pins must be connected directly to the board ground.



The VDD and VDDIO supplies should be decoupled close to the chip by several 100 nF low inductance multi-layer ceramic capacitors between the supplies and GND (for example, 4x100nF 0402 low inductance MLCCs per supply rail). The ground side of the decoupling capacitors should have as short a path back to the GND pins as possible. A bulk decoupling capacitor of at least 10 uF should be placed on each of these supplies.

RST_N is an active-low asynchronous-assertion global reset signal. Following a reset, the PLL re-establishes lock after which the device boots up according to the boot mode (*see* §7). RST_N and must be asserted low during and after power up for 100 ns.

10.1 Land patterns and solder stencils

The land pattern recommendations in this document are based on a RoHS compliant process and derived, where possible, from the nominal *Generic Requirements for Surface Mount Design and Land Pattern Standards* IPC-7351B specifications. This standard aims to achieve desired targets of heel, toe and side fillets for solder-joints.

Solder paste and ground via recommendations are based on our engineering and development kit board production. They have been found to work and optimized as appropriate to achieve a high yield. The size, type and number of vias used in the center pad affects how much solder wicks down the vias during reflow. This in turn, along with solder paster coverage, affects the final assembled package height. These factors should be taken into account during design and manufacturing of the PCB.

The following land patterns and solder paste contains recommendations. Final land pattern and solder paste decisions are the responsibility of the customer. These should be tuned during manufacture to suit the manufacturing process.

The package is a 48 pin Thin Quad Flat Pack package with exposed heat slug on a 0.5mm pitch. An example land pattern is shown in Figure 12.

For the 48 pin TQFP package, a single square of solder paste, 2.7mm on a side, is recommended - see Figure 13. This gives a paste level of 52%.

10.2 Ground and Thermal Vias

Vias under the heat slug into the ground plane of the PCB are recommended for a low inductance ground connection and good thermal performance. A 3×3 grid of vias, with a 0.6mm diameter annular ring and a 0.3mm drill, equally spaced across the heat slug, would be suitable.

10.3 Moisture Sensitivity

XMOS devices are, like all semiconductor devices, susceptible to moisture absorption. When removed from the sealed packaging, the devices slowly absorb moisture from the surrounding environment. If the level of moisture present in the device is too high during reflow, damage can occur due to the increased internal vapour



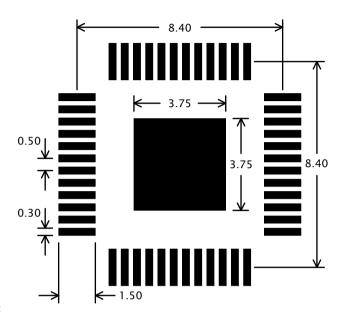


Figure 12: Example land pattern

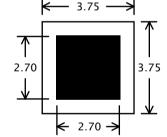


Figure 13: Solder stencil for centre

pressure of moisture. Example damage can include bond wire damage, die lifting, internal or external package cracks and/or delamination.

All XMOS devices are Moisture Sensitivity Level (MSL) 3 - devices have a shelf life of 168 hours between removal from the packaging and reflow, provided they are stored below 30C and 60% RH. If devices have exceeded these values or an included moisture indicator card shows excessive levels of moisture, then the parts should be baked as appropriate before use. This is based on information from Joint IPC/JEDEC Standard For Moisture/Reflow Sensitivity Classification For Nonhermetic Solid State Surface-Mount Devices J-STD-020 Revision D.



11 DC and Switching Characteristics

11.1 Operating Conditions

| Symbol | Parameter | MIN | TYP | MAX | UNITS | Notes |
|----------|---------------------------------|------|------|------|-------|-------|
| VDD | Tile DC supply voltage | 0.95 | 1.00 | 1.05 | V | |
| VDDIO | I/O supply voltage | 3.00 | 3.30 | 3.60 | V | |
| PLL_AVDD | PLL analog supply | 0.95 | 1.00 | 1.05 | V | |
| Cl | xCORE Tile I/O load capacitance | | | 25 | pF | |
| Та | Ambient operating temperature | 0 | | 70 | °C | |
| Та | Ambient operating temperature | -40 | | 85 | °C | |
| Tj | Junction temperature | | | 125 | °C | |
| Tstg | Storage temperature | -65 | | 150 | °C | |

Figure 14: Operating conditions

11.2 DC Characteristics

| Symbol | Parameter | MIN | TYP | MAX | UNITS | Notes |
|--------|----------------------|-------|-----|------|-------|-------|
| V(IH) | Input high voltage | 2.00 | | 3.60 | V | Α |
| V(IL) | Input low voltage | -0.30 | | 0.70 | V | Α |
| V(OH) | Output high voltage | 2.70 | | | ٧ | B, C |
| V(OL) | Output low voltage | | | 0.60 | V | B, C |
| R(PU) | Pull-up resistance | | 35K | | Ω | D |
| R(PD) | Pull-down resistance | | 35K | | Ω | D |

Figure 15: DC characteristics

- A All pins except power supply pins.
- B Ports 1A, 1D, 1E, 1H, 1I, 1J, 1K and 1L are nominal 8 mA drivers, the remainder of the general-purpose I/Os are 4 mA.
- C Measured with 4 mA drivers sourcing 4 mA, 8 mA drivers sourcing 8 mA.
- D Used to guarantee logic state for an I/O when high impedance. The internal pull-ups/pull-downs should not be used to pull external circuitry.

11.3 ESD Stress Voltage

Figure 16: ESD stress voltage

| Symbol | Parameter | MIN | TYP | MAX | UNITS | Notes |
|--------|------------------|-------|-----|------|-------|-------|
| HBM | Human body model | -2.00 | | 2.00 | KV | |
| MM | Machine model | -200 | | 200 | V | |



11.4 Reset Timing

Figure 17: Reset timing

| Symbol | Parameters | MIN | TYP | MAX | UNITS | Notes |
|---------|---------------------|-----|-----|-----|-------|-------|
| T(RST) | Reset pulse width | 5 | | | μs | |
| T(INIT) | Initialization time | | | 150 | μs | Α |

A Shows the time taken to start booting after RST_N has gone high.

11.5 Power Consumption

| Symbol | Parameter | MIN | TYP | MAX | UNITS | Notes |
|-----------|------------------------------------|-----|-----|-----|---------|------------|
| I(DDCQ) | Quiescent VDD current | | 14 | | mA | A, B, C |
| PD | Tile power dissipation | | 450 | | μW/MIPS | A, D, E, F |
| IDD | Active VDD current (Speed Grade 4) | | 160 | 300 | mA | A, G |
| | Active VDD current (Speed Grade 5) | | 200 | 375 | mA | A, H |
| I(ADDPLL) | PLL_AVDD current | | | 7 | mA | 1 |

Figure 18: xCORE Tile currents

- A Use for budgetary purposes only.
- B Assumes typical tile and I/O voltages with no switching activity.
- C Includes PLL current.
- D Assumes typical tile and I/O voltages with nominal switching activity.
- E Assumes 1 MHz = 1 MIPS.
- F PD(TYP) value is the usage power consumption under typical operating conditions.
- G Measurement conditions: VDD = $1.0\,\text{V}$, VDDIO = $3.3\,\text{V}$, $25\,^{\circ}\text{C}$, $400\,\text{MHz}$, average device resource usage.
- H Measurement conditions: VDD = $1.0\,\mathrm{V}$, VDDIO = $3.3\,\mathrm{V}$, $25\,^{\circ}\mathrm{C}$, $500\,\mathrm{MHz}$, average device resource usage.
- I $PLL_AVDD = 1.0 V$



The tile power consumption of the device is highly application dependent and should be used for budgetary purposes only.

More detailed power analysis can be found in the XS1-L Power Consumption document, X2999.



11.6 Clock

| Symbol | Parameter | MIN | TYP | MAX | UNITS | Notes |
|--------|----------------------------------------------|------|-----|-----|-------|-------|
| f | Frequency | 4.22 | 20 | 100 | MHz | |
| SR | Slew rate | 0.10 | | | V/ns | |
| TJ(LT) | Long term jitter (pk-pk) | | | 2 | % | Α |
| f(MAX) | Processor clock frequency (Speed Grade 4) | | | 400 | MHz | В |
| | Processor clock frequency (Speed Grade 5) | | | 500 | MHz | В |

Figure 19: Clock

A Percentage of CLK period.

B Assumes typical tile and I/O voltages with nominal activity.

Further details can be found in the XS1-L Clock Frequency Control document, X1433.

11.7 xCORE Tile I/O AC Characteristics

Figure 20: I/O AC characteristics

| Symbol | Parameter | MIN | TYP | MAX | UNITS | Notes |
|--------------|---------------------------------------------------------------------|-----|-----|-----|-------|-------|
| T(XOVALID) | Input data valid window | 8 | | | ns | |
| T(XOINVALID) | Output data invalid window | 9 | | | ns | |
| T(XIFMAX) | Rate at which data can be sampled with respect to an external clock | | | 60 | MHz | |

The input valid window parameter relates to the capability of the device to capture data input to the chip with respect to an external clock source. It is calculated as the sum of the input setup time and input hold time with respect to the external clock as measured at the pins. The output invalid window specifies the time for which an output is invalid with respect to the external clock. Note that these parameters are specified as a window rather than absolute numbers since the device provides functionality to delay the incoming clock with respect to the incoming data.

Information on interfacing to high-speed synchronous interfaces can be found in the XS1 Port I/O Timing document, X5821.

11.8 xConnect Link Performance

| Symbol | Parameter | MIN | TYP | MAX | UNITS | Notes |
|------------|-----------------------------------|-----|-----|-----|--------|-------|
| B(2blinkP) | 2wire link bandwidth (packetized) | | | 87 | MBit/s | A, B |
| B(5blinkP) | 5wire link bandwidth (packetized) | | | 217 | MBit/s | A, B |
| B(2blinkS) | 2wire link bandwidth (streaming) | | | 100 | MBit/s | В |
| B(5blinkS) | 5wire link bandwidth (streaming) | | | 250 | MBit/s | В |

Figure 21: Link performance

The asynchronous nature of links means that the relative phasing of CLK clocks is not important in a multi-clock system, providing each meets the required stability criteria.

11.9 JTAG Timing

| Symbol | Parameter | MIN | TYP | MAX | UNITS | Notes |
|----------|-------------------------------|-----|-----|-----|-------|-------|
| f(TCK_D) | TCK frequency (debug) | | | 18 | MHz | |
| f(TCK_B) | TCK frequency (boundary scan) | | | 10 | MHz | |
| T(SETUP) | TDO to TCK setup time | 5 | | | ns | Α |
| T(HOLD) | TDO to TCK hold time | 5 | | | ns | Α |
| T(DELAY) | TCK to output delay | | | 15 | ns | В |

Figure 22: JTAG timing

All JTAG operations are synchronous to TCK apart from the global asynchronous reset TRST_N.

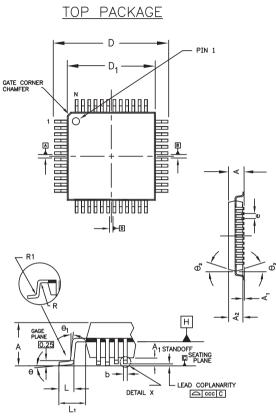
A Assumes 32-byte packet in 3-byte header mode. Actual performance depends on size of the header and payload.

B 7.5 ns symbol time.

A Timing applies to TMS and TDI inputs.

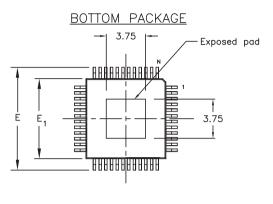
B Timing applies to TDO output from negative edge of TCK.

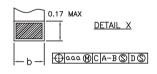
12 Package Information





- 1. All dimensions in millimeters.
- 2. Dimension tolerances shall be ± 0.05 mm unless otherwise specified.
- 3. Foot length 'L' is measured at gage plane 0.25mm above seating plane.
- Dimension D1 and E1 are bottom package width and length and are measured at datum plane H.
- 5. Leadframe material: Eftec 64T Cu (or equivalent), 0.127mm (0.005") thick.





| | LEAD COUNT | | 48L |
|-------------------|----------------|-------------|--------------|
| | DIMS. | TOL. | 1.0 mm THICK |
| SEAT HEIGHT | A | MAX. | 1.20 |
| STAND OFF | A ₁ | ±0.05 | 0.10 |
| PACKAGE THICKNESS | A ₂ | ±0.05 | 1.00 |
| O.D.WIDTH | D | ±0.20 | 9.00 |
| PACKAGE WIDTH | D ₁ | ±0.10 | 7.00 |
| O.D LENGTH | E | ±0.20 | 9.00 |
| PACKAGE LENGTH | E ₁ | ±0.10 | 7.00 |
| FOOT LENGTH | L | +0.15/-0.10 | 0.60 |
| HALF FOOTPRINT | L ₁ | REF | 1.00 |
| LEAD PITCH | е | TYPE | 0.50 |
| LEAD WIDTH | b | ±0.05 | 0.22 |
| FOOT ANGLE | Θ | | 0*-7* |
| VERTICAL ANGLE | θ1 | | O' MIN. |
| | θ2 | ±1* | 12* |
| FIRST BEND | R | TYP | 0.15 |
| SECOND BEND | R1 | ±0.05 | 0.15 |
| | aaa | MAX. | 0.08 |
| COPLANARITY | ccc | MAX. | 0.08 |
| | JEDEC REFERE | NCE DRAWING | MS-026 |
| | VARIATION DES | SIGNATOR | ABC |



12.1 Part Marking

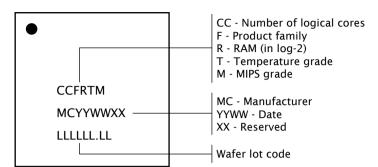


Figure 23: Part marking scheme

13 Ordering Information

Figure 24: Orderable part numbers

| Product Code | Marking | Qualification | Speed Grade |
|--------------------|---------|---------------|-------------|
| XS1-L6A-64-TQ48-C4 | 6L6C4 | Commercial | 400 MIPS |
| XS1-L6A-64-TQ48-C5 | 6L6C5 | Commercial | 500 MIPS |
| XS1-L6A-64-TQ48-I4 | 6L6I4 | Industrial | 400 MIPS |
| XS1-L6A-64-TQ48-I5 | 6L6I5 | Industrial | 500 MIPS |

Appendices

A Configuration of the XS1

The device is configured through three banks of registers, as shown in Figure 25.

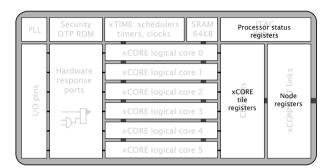


Figure 25: Registers

The following communication sequences specify how to access those registers. Any messages transmitted contain the most significant 24 bits of the channel-end to which a response is to be sent. This comprises the node-identifier and the channel number within the node. if no response is required on a write operation, supply 24-bits with the last 8-bits set, which suppresses the reply message. Any multi-byte data is sent most significant byte first.

A.1 Accessing a processor status register

The processor status registers are accessed directly from the processor instruction set. The instructions GETPS and SETPS read and write a word. The register number should be translated into a processor-status resource identifier by shifting the register number left 8 places, and ORing it with 0x0C. Alternatively, the functions getps(reg) and setps(reg,value) can be used from XC.

A.2 Accessing an xCORE Tile configuration register

xCORE Tile configuration registers can be accessed through the interconnect using the functions $write_tile_config_reg(tileref, ...)$ and $read_tile_config_reg(tile \hookrightarrow ref, ...)$, where tileref is the name of the xCORE Tile, e.g. tile[1]. These functions implement the protocols described below.

Instead of using the functions above, a channel-end can be allocated to communicate with the xCORE tile configuration registers. The destination of the channel-end should be set to OxnonnC2OC where nnnnnn is the tile-identifier.

A write message comprises the following:

| control-token | 24-bit response | 16-bit | 32-bit | control-token |
|---------------|------------------------|-----------------|--------|---------------|
| 192 | channel-end identifier | register number | data | 1 |



The response to a write message comprises either control tokens 3 and 1 (for success), or control tokens 4 and 1 (for failure).

A read message comprises the following:

| control-token | 24-bit response | 16-bit | control-token |
|---------------|------------------------|-----------------|---------------|
| 193 | channel-end identifier | register number | 1 |

The response to the read message comprises either control token 3, 32-bit of data, and control-token 1 (for success), or control tokens 4 and 1 (for failure).

A.3 Accessing node configuration

Node configuration registers can be accessed through the interconnect using the functions write_node_config_reg(device, ...) and read_node_config_reg(device, ...), where device is the name of the node. These functions implement the protocols described below.

Instead of using the functions above, a channel-end can be allocated to communicate with the node configuration registers. The destination of the channel-end should be set to OxnonnC30C where nnnn is the node-identifier.

A write message comprises the following:

| control-token | 24-bit response | 16-bit | 32-bit | control-token |
|---------------|------------------------|-----------------|--------|---------------|
| 192 | channel-end identifier | register number | data | 1 |

The response to a write message comprises either control tokens 3 and 1 (for success), or control tokens 4 and 1 (for failure).

A read message comprises the following:

| control-token | 24-bit response | 16-bit | control-token |
|---------------|------------------------|-----------------|---------------|
| 193 | channel-end identifier | register number | 1 |

The response to a read message comprises either control token 3, 32-bit of data, and control-token 1 (for success), or control tokens 4 and 1 (for failure).



B Processor Status Configuration

The processor status control registers can be accessed directly by the processor using processor status reads and writes (use getps(reg) and setps(reg,value) for reads and writes).

| Number | Perm | Description |
|-----------|------|---------------------------------------|
| 0x00 | RW | RAM base address |
| 0x01 | RW | Vector base address |
| 0x02 | RW | xCORE Tile control |
| 0x03 | RO | xCORE Tile boot status |
| 0x05 | RO | Security configuration |
| 0x06 | RW | Ring Oscillator Control |
| 0x07 | RO | Ring Oscillator Value |
| 0x08 | RO | Ring Oscillator Value |
| 0x09 | RO | Ring Oscillator Value |
| 0x0A | RO | Ring Oscillator Value |
| 0x10 | DRW | Debug SSR |
| 0x11 | DRW | Debug SPC |
| 0x12 | DRW | Debug SSP |
| 0x13 | DRW | DGETREG operand 1 |
| 0x14 | DRW | DGETREG operand 2 |
| 0x15 | DRW | Debug interrupt type |
| 0x16 | DRW | Debug interrupt data |
| 0x18 | DRW | Debug core control |
| 0x20 0x27 | DRW | Debug scratch |
| 0x30 0x33 | DRW | Instruction breakpoint address |
| 0x40 0x43 | DRW | Instruction breakpoint control |
| 0x50 0x53 | DRW | Data watchpoint address 1 |
| 0x60 0x63 | DRW | Data watchpoint address 2 |
| 0x70 0x73 | DRW | Data breakpoint control register |
| 0x80 0x83 | DRW | Resources breakpoint mask |
| 0x90 0x93 | DRW | Resources breakpoint value |
| 0x9C 0x9F | DRW | Resources breakpoint control register |

Figure 26: Summary



B.1 RAM base address: 0x00

This register contains the base address of the RAM. It is initialized to 0x00010000.

0x00: RAM base address

| Bits | Perm | Init | Description |
|------|------|------|--------------------------------------------|
| 31:2 | RW | | Most significant 16 bits of all addresses. |
| 1:0 | RO | - | Reserved |

B.2 Vector base address: 0x01

Base address of event vectors in each resource. On an interrupt or event, the 16 most significant bits of the destination address are provided by this register; the least significant 16 bits come from the event vector.

0x01: Vector base address

| Bits | Perm | Init | Description |
|-------|------|------|----------------------------------------------------------------|
| 31:16 | RW | | The most significant bits for all event and interrupt vectors. |
| 15:0 | RO | - | Reserved |

B.3 xCORE Tile control: 0x02

Register to control features in the xCORE tile

| | Bits | Perm | Init | Description |
|---|------|------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | 31:6 | RO | - | Reserved |
| | 5 | RW | 0 | Set to 1 to select the dynamic mode for the clock divider when the clock divider is enabled. In dynamic mode the clock divider is only activated when all active logical cores are paused. In static mode the clock divider is always enabled. |
| | 4 | RW | 0 | Set to 1 to enable the clock divider. This slows down the xCORE tile clock in order to use less power. |
| Ì | 3:0 | RO | _ | Reserved |

0x02: xCORE Tile control

B.4 xCORE Tile boot status: 0x03

This read-only register describes the boot status of the xCORE tile.



| Bits | Perm | Init | Description |
|-------|------|------|------------------------------------------------------------------------------------|
| 31:24 | RO | - | Reserved |
| 23:16 | RO | | xCORE tile number on the switch. |
| 15:9 | RO | - | Reserved |
| 8 | RO | | Set to 1 if boot from OTP is enabled. |
| 7:0 | RO | | The boot mode pins MODE0, MODE1,, specifying the boot frequency, boot source, etc. |

0x03: xCORE Tile boot status

B.5 Security configuration: 0x05

Copy of the security register as read from OTP.

0x05: Security configuration

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

B.6 Ring Oscillator Control: 0x06

There are four free-running oscillators that clock four counters. The oscillators can be started and stopped using this register. The counters should only be read when the ring oscillator is stopped. The counter values can be read using four subsequent registers. The ring oscillators are asynchronous to the xCORE tile clock and can be used as a source of random bits.

0x06: Ring Oscillator Control

| Bits | Perm | Init | Description |
|------|------|------|----------------------------------------------------|
| 31:2 | RO | - | Reserved |
| 1 | RW | 0 | Set to 1 to enable the xCORE tile ring oscillators |
| 0 | RW | 0 | Set to 1 to enable the peripheral ring oscillators |

B.7 Ring Oscillator Value: 0x07

This register contains the current count of the xCORE Tile Cell ring oscillator. This value is not reset on a system reset.

0x07: Ring Oscillator Value

| Bits | Perm | Init | Description |
|-------|------|------|-------------------------------|
| 31:16 | RO | - | Reserved |
| 15:0 | RO | - | Ring oscillator counter data. |



B.8 Ring Oscillator Value: 0x08

This register contains the current count of the xCORE Tile Wire ring oscillator. This value is not reset on a system reset.

0x08: Ring Oscillator Value

| Bits | Perm | Init | Description |
|-------|------|------|-------------------------------|
| 31:16 | RO | - | Reserved |
| 15:0 | RO | - | Ring oscillator counter data. |

B.9 Ring Oscillator Value: 0x09

This register contains the current count of the Peripheral Cell ring oscillator. This value is not reset on a system reset.

0x09: Ring Oscillator Value

| Bits | Perm | Init | Description |
|-------|------|------|-------------------------------|
| 31:16 | RO | - | Reserved |
| 15:0 | RO | - | Ring oscillator counter data. |

B.10 Ring Oscillator Value: 0x0A

This register contains the current count of the Peripheral Wire ring oscillator. This value is not reset on a system reset.

0x0A: Ring Oscillator Value

| Bits | Perm | Init | Description |
|-------|------|------|-------------------------------|
| 31:16 | RO | - | Reserved |
| 15:0 | RO | - | Ring oscillator counter data. |

B.11 Debug SSR: 0x10

This register contains the value of the SSR register when the debugger was called.

0x10: Debug SSR

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | - | Reserved |

B.12 Debug SPC: 0x11

This register contains the value of the SPC register when the debugger was called.



0x11: Debug SPC

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.13 Debug SSP: 0x12

This register contains the value of the SSP register when the debugger was called.

0x12: Debug SSP

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.14 DGETREG operand 1: 0x13

The resource ID of the logical core whose state is to be read.

0x13: DGETREG operand 1

| Bits | Perm | Init | Description |
|------|------|------|--------------------------|
| 31:8 | RO | - | Reserved |
| 7:0 | DRW | | Thread number to be read |

B.15 DGETREG operand 2: 0x14

Register number to be read by DGETREG

0x14: DGETREG operand 2

| Bits | Perm | Init | Description |
|------|------|------|----------------------------|
| 31:5 | RO | - | Reserved |
| 4:0 | DRW | | Register number to be read |

B.16 Debug interrupt type: 0x15

Register that specifies what activated the debug interrupt.



| Bits | Perm | Init | Description |
|-------|------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 31:18 | RO | - | Reserved |
| 17:16 | DRW | | If the debug interrupt was caused by a hardware breakpoint or hardware watchpoint, this field contains the number of the breakpoint or watchpoint. If multiple breakpoints or watchpoints trigger at once, the lowest number is taken. |
| 15:8 | DRW | | If the debug interrupt was caused by a logical core, this field contains the number of that core. Otherwise this field is 0. |
| 7:3 | RO | - | Reserved |
| 2:0 | DRW | 0 | Indicates the cause of the debug interrupt 1: Host initiated a debug interrupt through JTAG 2: Program executed a DCALL instruction 3: Instruction breakpoint 4: Data watch point 5: Resource watch point |

0x15: Debug interrupt type

B.17 Debug interrupt data: 0x16

On a data watchpoint, this register contains the effective address of the memory operation that triggered the debugger. On a resource watchpoint, it countains the resource identifier.

0x16: Debug interrupt data

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.18 Debug core control: 0x18

This register enables the debugger to temporarily disable logical cores. When returning from the debug interrupts, the cores set in this register will not execute. This enables single stepping to be implemented.

0x18: Debug core control

| Bits | Perm | Init | Description |
|------|------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 31:8 | RO | - | Reserved |
| 7:0 | DRW | | 1-hot vector defining which logical cores are stopped when not in debug mode. Every bit which is set prevents the respective logical core from running. |



B.19 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over JTAG. This is the same set of registers as the Debug Scratch registers in the xCORE tile configuration.

0x20 .. 0x27: Debug scratch

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.20 Instruction breakpoint address: 0x30 .. 0x33

This register contains the address of the instruction breakpoint. If the PC matches this address, then a debug interrupt will be taken. There are four instruction breakpoints that are controlled individually.

0x30 .. 0x33: Instruction breakpoint address

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.21 Instruction breakpoint control: 0x40 .. 0x43

This register controls which logical cores may take an instruction breakpoint, and under which condition.

| | Bits | Perm | Init | Description |
|---|-------|------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | 31:24 | RO | - | Reserved |
| | 23:16 | DRW | 0 | A bit for each logical core in the tile allowing the breakpoint to be enabled individually for each logical core. |
| | 15:2 | RO | - | Reserved |
| | 1 | DRW | 0 | Set to 1 to cause an instruction breakpoint if the PC is not equal to the breakpoint address. By default, the breakpoint is triggered when the PC is equal to the breakpoint address. |
| ſ | 0 | DRW | 0 | When 1 the instruction breakpoint is enabled. |

0x40 .. 0x43: Instruction breakpoint control

B.22 Data watchpoint address 1: 0x50 ... 0x53

This set of registers contains the first address for the four data watchpoints.



0x50 .. 0x53: Data watchpoint address 1

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.23 Data watchpoint address 2: 0x60 .. 0x63

This set of registers contains the second address for the four data watchpoints.

0x60 .. 0x63: Data watchpoint address 2

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.24 Data breakpoint control register: 0x70 .. 0x73

This set of registers controls each of the four data watchpoints.

| Bits | Perm | Init | Description |
|-------|------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 31:24 | RO | - | Reserved |
| 23:16 | DRW | 0 | A bit for each logical core in the tile allowing the breakpoint to be enabled individually for each logical core. |
| 15:3 | RO | - | Reserved |
| 2 | DRW | 0 | Set to 1 to enable breakpoints to be triggered on loads. Breakpoints always trigger on stores. |
| 1 | DRW | 0 | By default, data watchpoints trigger if memory in the range [Address1Address2] is accessed (the range is inclusive of Address1 and Address2). If set to 1, data watchpoints trigger if memory outside the range (Address2Address1) is accessed (the range is exclusive of Address2 and Address1). |
| 0 | DRW | 0 | When 1 the instruction breakpoint is enabled. |

0x70 .. 0x73: Data breakpoint control register

B.25 Resources breakpoint mask: 0x80 .. 0x83

This set of registers contains the mask for the four resource watchpoints.



0x80 .. 0x83: Resources breakpoint mask

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.26 Resources breakpoint value: 0x90 .. 0x93

This set of registers contains the value for the four resource watchpoints.

0x90 .. 0x93: Resources breakpoint value

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | DRW | | Value. |

B.27 Resources breakpoint control register: 0x9C .. 0x9F

This set of registers controls each of the four resource watchpoints.

| Bits | Perm | Init | Description |
|-------|------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 31:24 | RO | - | Reserved |
| 23:16 | DRW | 0 | A bit for each logical core in the tile allowing the breakpoint to be enabled individually for each logical core. |
| 15:2 | RO | - | Reserved |
| 1 | DRW | 0 | By default, resource watchpoints trigger when the resource id masked with the set Mask equals the Value. If set to 1, resource watchpoints trigger when the resource id masked with the set Mask is not equal to the Value. |
| 0 | DRW | 0 | When 1 the instruction breakpoint is enabled. |

0x9C .. 0x9F: Resources breakpoint control register



C Tile Configuration

The xCORE Tile control registers can be accessed using configuration reads and writes (use write_tile_config_reg(tileref, ...) and read_tile_config_reg(tileref, ...) for reads and writes).

| Number | Perm | Description |
|-----------|------|------------------------------------------------|
| 0x00 | RO | Device identification |
| 0x01 | RO | xCORE Tile description 1 |
| 0x02 | RO | xCORE Tile description 2 |
| 0x04 | CRW | Control PSwitch permissions to debug registers |
| 0x05 | CRW | Cause debug interrupts |
| 0x06 | RW | xCORE Tile clock divider |
| 0x07 | RO | Security configuration |
| 0x10 0x13 | RO | PLink status |
| 0x20 0x27 | CRW | Debug scratch |
| 0x40 | RO | PC of logical core 0 |
| 0x41 | RO | PC of logical core 1 |
| 0x42 | RO | PC of logical core 2 |
| 0x43 | RO | PC of logical core 3 |
| 0x44 | RO | PC of logical core 4 |
| 0x45 | RO | PC of logical core 5 |
| 0x60 | RO | SR of logical core 0 |
| 0x61 | RO | SR of logical core 1 |
| 0x62 | RO | SR of logical core 2 |
| 0x63 | RO | SR of logical core 3 |
| 0x64 | RO | SR of logical core 4 |
| 0x65 | RO | SR of logical core 5 |
| 0x80 0x9F | RO | Chanend status |

Figure 27: Summary



C.1 Device identification: 0x00

| Bits | Perm | Init | Description |
|-------|------|------|---------------------------------------------------------|
| 31:24 | RO | | Processor ID of this xCORE tile. |
| 23:16 | RO | | Number of the node in which this xCORE tile is located. |
| 15:8 | RO | | xCORE tile revision. |
| 7:0 | RO | | xCORE tile version. |

0x00:Device identification

C.2 xCORE Tile description 1: 0x01

This register describes the number of logical cores, synchronisers, locks and channel ends available on this xCORE tile.

| Bits | Perm | Init | Description |
|-------|------|------|--------------------------|
| 31:24 | RO | | Number of channel ends. |
| 23:16 | RO | | Number of locks. |
| 15:8 | RO | | Number of synchronisers. |
| 7:0 | RO | - | Reserved |

0x01: xCORE Tile description 1

C.3 xCORE Tile description 2: 0x02

This register describes the number of timers and clock blocks available on this $xCORE\ tile.$

0x02: xCORE Tile description 2

| Bits | Perm | Init | Description |
|-------|------|------|-------------------------|
| 31:16 | RO | - | Reserved |
| 15:8 | RO | | Number of clock blocks. |
| 7:0 | RO | | Number of timers. |

C.4 Control PSwitch permissions to debug registers: 0x04

This register can be used to control whether the debug registers (marked with permission CRW) are accessible through the tile configuration registers. When this bit is set, write -access to those registers is disabled, preventing debugging of the xCORE tile over the interconnect.



0x04: Control PSwitch permissions to debug registers

| Bits | Perm | Init | Description |
|------|------|------|-------------------------------------------------------------------------------------------------------------|
| 31:1 | RO | - | Reserved |
| 0 | CRW | | Set to 1 to restrict PSwitch access to all CRW marked registers to become read-only rather than read-write. |

C.5 Cause debug interrupts: 0x05

This register can be used to raise a debug interrupt in this xCORE tile.

0x05: Cause debug interrupts

| Bits | Perm | Init | Description |
|------|------|------|---------------------------------------------------------|
| 31:2 | RO | - | Reserved |
| 1 | RO | 0 | Set to 1 when the processor is in debug mode. |
| 0 | CRW | 0 | Set to 1 to request a debug interrupt on the processor. |

C.6 xCORE Tile clock divider: 0x06

This register contains the value used to divide the PLL clock to create the xCORE tile clock. The divider is enabled under control of the tile control register

0x06: xCORE Tile clock divider

| Bits | Perm | Init | Description |
|------|------|------|---------------------------------------|
| 31:8 | RO | - | Reserved |
| 7:0 | RW | | Value of the clock divider minus one. |

C.7 Security configuration: 0x07

Copy of the security register as read from OTP.

0x07: Security configuration

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

C.8 PLink status: 0x10 .. 0x13

Status of each of the four processor links; connecting the xCORE tile to the switch.



| Bits | Perm | Init | Description |
|-------|------|------|----------------------------------------------------------------------------------------------------------------|
| 31:26 | RO | - | Reserved |
| 25:24 | RO | | 00 - ChannelEnd, 01 - ERROR, 10 - PSCTL, 11 - Idle. |
| 23:16 | RO | | Based on SRC_TARGET_TYPE value, it represents channelEnd ID or Idle status. |
| 15:6 | RO | - | Reserved |
| 5:4 | RO | | Two-bit network identifier |
| 3 | RO | - | Reserved |
| 2 | RO | | 1 when the current packet is considered junk and will be thrown away. |
| 1 | RO | 0 | Set to 1 if the switch is routing data into the link, and if a route exists from another link. |
| 0 | RO | 0 | Set to 1 if the link is routing data into the switch, and if a route is created to another link on the switch. |

0x10 .. 0x13: PLink status

C.9 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over the switch. This is the same set of registers as the Debug Scratch registers in the processor status.

0x20 .. 0x27: Debug scratch

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | CRW | | Value. |

C.10 PC of logical core 0: 0x40

Value of the PC of logical core 0.

0x40: PC of logical core 0

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |



C.11 PC of logical core 1: 0x41

0x41: PC of logical core 1

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

C.12 PC of logical core 2: 0x42

0x42: PC of logical core 2

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

C.13 PC of logical core 3: 0x43

0x43: PC of logical core 3

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

C.14 PC of logical core 4: 0x44

0x44: PC of logical core 4

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

C.15 PC of logical core 5: 0x45

0x45: PC of logical core 5

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

C.16 SR of logical core 0: 0x60

Value of the SR of logical core 0



0x60: SR of logical core 0

| Bits | Perm | Init | Description | |
|------|------|------|-------------|--|
| 31:0 | RO | | Value. | |

C.17 SR of logical core 1: 0x61

0x61: SR of logical core 1

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

C.18 SR of logical core 2: 0x62

0x62: SR of logical core 2

| Bits | Perm | Init | Description | |
|------|------|------|-------------|--|
| 31:0 | RO | | Value. | |

C.19 SR of logical core 3: 0x63

0x63: SR of logical core 3

| Bits | Perm | Init | Description | |
|------|------|------|-------------|--|
| 31:0 | RO | | Value. | |

C.20 SR of logical core 4: 0x64

0x64: SR of logical core 4

| Bits | Perm | Init | Description |
|------|------|------|-------------|
| 31:0 | RO | | Value. |

C.21 SR of logical core 5: 0x65

0x65: SR of logical core 5

| Bits | Perm | Init | Description | |
|------|------|------|-------------|--|
| 31:0 | RO | | Value. | |



C.22 Chanend status: 0x80 .. 0x9F

These registers record the status of each channel-end on the tile.

| Bits | Perm | Init | Description |
|-------|------|------|----------------------------------------------------------------------------------------------------------------|
| 31:26 | RO | - | Reserved |
| 25:24 | RO | | 00 - ChannelEnd, 01 - ERROR, 10 - PSCTL, 11 - Idle. |
| 23:16 | RO | | Based on SRC_TARGET_TYPE value, it represents channelEnd ID or Idle status. |
| 15:6 | RO | - | Reserved |
| 5:4 | RO | | Two-bit network identifier |
| 3 | RO | - | Reserved |
| 2 | RO | | 1 when the current packet is considered junk and will be thrown away. |
| 1 | RO | 0 | Set to 1 if the switch is routing data into the link, and if a route exists from another link. |
| 0 | RO | 0 | Set to 1 if the link is routing data into the switch, and if a route is created to another link on the switch. |

0x80 .. 0x9F: Chanend status



D Node Configuration

The digital node control registers can be accessed using configuration reads and writes (use write_node_config_reg(device, ...) and read_node_config_reg(device, ...) for reads and writes).

| Number | Perm | Description |
|-----------|------|---------------------------------------|
| 0x00 | RO | Device identification |
| 0x01 | RO | System switch description |
| 0x04 | RW | Switch configuration |
| 0x05 | RW | Switch node identifier |
| 0x06 | RW | PLL settings |
| 0x07 | RW | System switch clock divider |
| 0x08 | RW | Reference clock |
| 0x0C | RW | Directions 0-7 |
| 0x0D | RW | Directions 8-15 |
| 0x10 | RW | DEBUG_N configuration |
| 0x1F | RO | Debug source |
| 0x20 0x27 | RW | Link status, direction, and network |
| 0x40 0x43 | RW | PLink status and network |
| 0x80 0x87 | RW | Link configuration and initialization |
| 0xA0 0xA7 | RW | Static link configuration |

Figure 28: Summary

D.1 Device identification: 0x00

This register contains version and revision identifiers and the mode-pins as sampled at boot-time.

| Bits | Perm | Init | Description |
|-------|------|------|------------------------------------------------|
| 31:24 | RO | 0x00 | Chip identifier. |
| 23:16 | RO | | Sampled values of pins MODE0, MODE1, on reset. |
| 15:8 | RO | | SSwitch revision. |
| 7:0 | RO | | SSwitch version. |

0x00:Device identification

D.2 System switch description: 0x01

This register specifies the number of processors and links that are connected to this switch.



0x01: System switch description

| Bits | Perm | Init | Description |
|-------|------|------|----------------------------------------------------|
| 31:24 | RO | - | Reserved |
| 23:16 | RO | | Number of links on the switch. |
| 15:8 | RO | | Number of cores that are connected to this switch. |
| 7:0 | RO | | Number of links per processor. |

D.3 Switch configuration: 0x04

This register enables the setting of two security modes (that disable updates to the PLL or any other registers) and the header-mode.

| Bits | Perm | Init | Description | |
|------|------|------|----------------------------------------------------------------------------------------------------|--|
| 31 | RO | 0 | Set to 1 to disable any write access to the configuration register in this switch. | |
| 30:9 | RO | - | Reserved | |
| 8 | RO | 0 | Set to 1 to disable updates to the PLL configuration register. | |
| 7:1 | RO | - | Reserved | |
| 0 | RO | 0 | Header mode. Set to 1 to enable 1-byte headers. This must be performed on all nodes in the system. | |

0x04: Switch configuration

D.4 Switch node identifier: 0x05

This register contains the node identifier.

| | Bits | Perm | Init | Description |
|--------------------------------|-------|------|------|----------------------------------------------------------------------------------------------------------------------------------------|
| | 31:16 | RO | - | Reserved |
|)x05: node tifier | 15:0 | RW | 0 | The unique 16-bit ID of this node. This ID is matched most- significant-bit first with incoming messages for routing pur- poses. |

0x05: Switch node identifier

D.5 PLL settings: 0x06

An on-chip PLL multiplies the input clock up to a higher frequency clock, used to clock the I/O, processor, and switch, see Oscillator. Note: a write to this register will cause the tile to be reset.



| Bits | Perm | Init | Description | |
|-------|------|------|-------------------------------------------------------------------------------------|--|
| 31:26 | RO | - | Reserved | |
| 25:23 | RW | | OD: Output divider value The initial value depends on pins MODE0 and MODE1. | |
| 22:21 | RO | - | Reserved | |
| 20:8 | RW | | F: Feedback multiplication ratio The initial value depends on pins MODE0 and MODE1. | |
| 7 | RO | - | Reserved | |
| 6:0 | RW | | R: Oscilator input divider value The initial value depends on pins MODE0 and MODE1. | |

0x06: PLL settings

D.6 System switch clock divider: 0x07

Sets the ratio of the PLL clock and the switch clock.

0x07:System switch clock divider

| Bits | Perm | Init | Description |
|-------|------|------|--------------------------------------------------------------------------------------------------------|
| 31:16 | RO | - | Reserved |
| 15:0 | RW | 0 | Switch clock divider. The PLL clock will be divided by this value plus one to derive the switch clock. |

D.7 Reference clock: 0x08

Sets the ratio of the PLL clock and the reference clock used by the node.

0x08: Reference clock

| Bits | Perm | Init | Description |
|-------|------|------|-----------------------------------------------------------------------------------------------------------------------------------|
| 31:16 | RO | - | Reserved |
| 15:0 | RW | 3 | Architecture reference clock divider. The PLL clock will be divided by this value plus one to derive the 100 MHz reference clock. |

D.8 Directions 0-7: 0x0C

This register contains eight directions, for packets with a mismatch in bits 7..0 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.



| Bits | Perm | Init | Description | |
|-------|------|------|-------------------------------------------------------------|--|
| 31:28 | RW | 0 | The direction for packets whose first mismatching bit is 7. | |
| 27:24 | RW | 0 | The direction for packets whose first mismatching bit is 6. | |
| 23:20 | RW | 0 | The direction for packets whose first mismatching bit is 5. | |
| 19:16 | RW | 0 | The direction for packets whose first mismatching bit is 4. | |
| 15:12 | RW | 0 | The direction for packets whose first mismatching bit is 3. | |
| 11:8 | RW | 0 | The direction for packets whose first mismatching bit is 2. | |
| 7:4 | RW | 0 | The direction for packets whose first mismatching bit is 1. | |
| 3:0 | RW | 0 | The direction for packets whose first mismatching bit is 0. | |

0x0C: Directions 0-7

D.9 Directions 8-15: 0x0D

This register contains eight directions, for packets with a mismatch in bits 15..8 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.

| Bits | Perm | Init | Description | |
|-------|------|------|--------------------------------------------------------------|--|
| 31:28 | RW | 0 | The direction for packets whose first mismatching bit is 15. | |
| 27:24 | RW | 0 | The direction for packets whose first mismatching bit is 14. | |
| 23:20 | RW | 0 | The direction for packets whose first mismatching bit is 13. | |
| 19:16 | RW | 0 | The direction for packets whose first mismatching bit is 12. | |
| 15:12 | RW | 0 | The direction for packets whose first mismatching bit is 11. | |
| 11:8 | RW | 0 | The direction for packets whose first mismatching bit is 10. | |
| 7:4 | RW | 0 | The direction for packets whose first mismatching bit is 9. | |
| 3:0 | RW | 0 | The direction for packets whose first mismatching bit is 8. | |

0x0D: Directions 8-15

D.10 DEBUG_N configuration: 0x10

Configures the behavior of the DEBUG_N pin.

| Bits | Perm | Init | Description |
|------|------|------|--------------------------------------------------------------------------------------|
| 31:2 | RO | - | Reserved |
| 1 | RW | 0 | Set to 1 to enable signals on DEBUG_N to generate DCALL on the core. |
| 0 | RW | 0 | When set to 1, the DEBUG_N wire will be pulled down when the node enters debug mode. |

0x10: DEBUG_N configuration



D.11 Debug source: 0x1F

Contains the source of the most recent debug event.

| Bits | Perm | Init | Description |
|------|------|------|------------------------------------------------------------------------------------|
| 31:5 | RO | - | Reserved |
| 4 | RW | | If set, the external DEBUG_N pin is the source of the most recent debug interrupt. |
| 3:1 | RO | - | Reserved |
| 0 | RW | | If set, the xCORE Tile is the source of the most recent debug interrupt. |

0x1F: Debug source

D.12 Link status, direction, and network: 0x20 .. 0x27

These registers contain status information for low level debugging (read-only), the network number that each link belongs to, and the direction that each link is part of

| Bits | Perm | Init | Description |
|-------|------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 31:26 | RO | - | Reserved |
| 25:24 | RO | | If this link is currently routing data into the switch, this field specifies the type of link that the data is routed to: 0: external link 1: plink 2: internal control link |
| 23:16 | RO | 0 | If the link is routing data into the switch, this field specifies the destination link number to which all tokens are sent. |
| 15:12 | RO | - | Reserved |
| 11:8 | RW | 0 | The direction that this this link is associated with; set for routing. |
| 7:6 | RO | - | Reserved |
| 5:4 | RW | 0 | Determines the network to which this link belongs, set for quality of service. |
| 3 | RO | - | Reserved |
| 2 | RO | 0 | Set to 1 if the current packet is junk and being thrown away. A packet is considered junk if, for example, it is not routable. |
| 1 | RO | 0 | Set to 1 if the switch is routing data into the link, and if a route exists from another link. |
| 0 | RO | 0 | Set to 1 if the link is routing data into the switch, and if a route is created to another link on the switch. |

0x20 .. 0x27: Link status, direction, and network



D.13 PLink status and network: 0x40 .. 0x43

These registers contain status information and the network number that each processor-link belongs to.

| Bits | Perm | Init | Description | |
|-------|------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| 31:26 | RO | - | Reserved | |
| 25:24 | RO | | If this link is currently routing data into the switch, this field specifies the type of link that the data is routed to: 0: external link 1: plink 2: internal control link | |
| 23:16 | RO | 0 | If the link is routing data into the switch, this field specifies the destination link number to which all tokens are sent. | |
| 15:6 | RO | - | Reserved | |
| 5:4 | RW | 0 | Determines the network to which this link belongs, set for quality of service. | |
| 3 | RO | - | Reserved | |
| 2 | RO | 0 | Set to 1 if the current packet is junk and being thrown away. A packet is considered junk if, for example, it is not routable. | |
| 1 | RO | 0 | Set to 1 if the switch is routing data into the link, and if a route exists from another link. | |
| 0 | RO | 0 | Set to 1 if the link is routing data into the switch, and if a route is created to another link on the switch. | |

0x40 .. 0x43: PLink status and network

D.14 Link configuration and initialization: 0x80 .. 0x87

These registers contain configuration and debugging information specific to external links. The link speed and width can be set, the link can be initialized, and the link status can be monitored.



| Bits | Perm | Init | Description | |
|-------|------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| 31 | RW | 0 | Write '1' to this bit to enable the link, write '0' to disable it. This bit controls the muxing of ports with overlapping links. | |
| 30 | RW | 0 | Set to 0 to operate in 2 wire mode or 1 to operate in 5 wire mode | |
| 29:28 | RO | - | Reserved | |
| 27 | RO | 0 | Set to 1 on error: an RX buffer overflow or illegal token encoding has been received. This bit clears on reading. | |
| 26 | RO | 0 | 1 if this end of the link has issued credit to allow the remote end to transmit. | |
| 25 | RO | 0 | 1 if this end of the link has credits to allow it to transmit. | |
| 24 | WO | 0 | Set to 1 to initialize a half-duplex link. This clears this end of the link's credit and issues a HELLO token; the other side of the link will reply with credits. This bit is self-clearing. | |
| 23 | WO | 0 | Set to 1 to reset the receiver. The next symbol that is detected will be assumed to be the first symbol in a token. This bit is self-clearing. | |
| 22 | RO | - | Reserved | |
| 21:11 | RW | 0 | The number of system clocks between two subsequent transitions within a token | |
| 10:0 | RW | 0 | The number of system clocks between two subsequent transmit tokens. | |

0x80 .. 0x87: Link configuration and initialization

D.15 Static link configuration: 0xA0 .. 0xA7

These registers are used for static (ie, non-routed) links. When a link is made static, all traffic is forwarded to the designated channel end and no routing is attempted.

| Bits | Perm | Init | Description | |
|------|------|------|-------------------------------------------------------------------------------------------------|--|
| 31 | RW | 0 | Enable static forwarding. | |
| 30:5 | RO | - | Reserved | |
| 4:0 | RW | 0 | The destination channel end on this node that packets received in static mode are forwarded to. | |

0xA0 .. 0xA7: Static link configuration



E XMOS USB Interface

XMOS provides a low-level USB interface for connecting the device to a USB transceiver using the UTMI+ Low Pin Interface (ULPI). The ULPI signals must be connected to the pins named in Figure 29. Note also that some ports on the same tile are used internally and are not available for use when the USB driver is active (they are available otherwise).

| Pin | Signal |
|----------------|-------------------------|
| X <i>n</i> D02 | |
| XnD03 | |
| XnD04 | |
| XnD05 | Unavailable when USB |
| XnD06 | active |
| XnD07 | |
| XnD08 | |
| X <i>n</i> D09 | |

| Pin | Signal |
|----------------|--------------|
| X <i>n</i> D12 | ULPI_STP |
| X <i>n</i> D13 | ULPI_NXT |
| X <i>n</i> D14 | ULPI_DATA[0] |
| X <i>n</i> D15 | ULPI_DATA[1] |
| X <i>n</i> D16 | ULPI_DATA[2] |
| X <i>n</i> D17 | ULPI_DATA[3] |
| X <i>n</i> D18 | ULPI_DATA[4] |
| X <i>n</i> D19 | ULPI_DATA[5] |
| X <i>n</i> D20 | ULPI_DATA[6] |
| X <i>n</i> D21 | ULPI_DATA[7] |
| XnD22 | ULPI_DIR |
| XnD23 | ULPI_CLK |

| Pin | Signal |
|----------------|-------------------------|
| XnD26 | |
| XnD27 | |
| XnD28 | |
| XnD29 | Unavailable when USB |
| X <i>n</i> D30 | active |
| X <i>n</i> D31 | |
| XnD32 | |
| XnD33 | |

| X <i>n</i> D37 | |
|----------------|-------------|
| X <i>n</i> D38 | |
| X <i>n</i> D39 | Unavailable |
| X <i>n</i> D40 | when USB |
| X <i>n</i> D41 | active |
| X <i>n</i> D42 | |
| X <i>n</i> D43 | |

Figure 29: ULPI signals provided by the XMOS USB driver

F Device Errata

This section describes minor operational differences from the data sheet and recommended workarounds. As device and documentation issues become known, this section will be updated the document revised.

To guarantee a logic low is seen on the pins RST_N, MODE[3:0], TRST_N, TMS, TCK and TDI, the driving circuit should present an impedance of less than $100\,\Omega$ to ground. Usually this is not a problem for CMOS drivers driving single inputs. If one or more of these inputs are placed in parallel, however, additional logic buffers may be required to guarantee correct operation.

For static inputs tied high or low, the relevant input pin should be tied directly to GND or VDDIO.



G JTAG, xSCOPE and Debugging

If you intend to design a board that can be used with the XMOS toolchain and xTAG debugger, you will need an xSYS header on your board. Figure 30 shows a decision diagram which explains what type of xSYS connectivity you need. The three subsections below explain the options in detail.

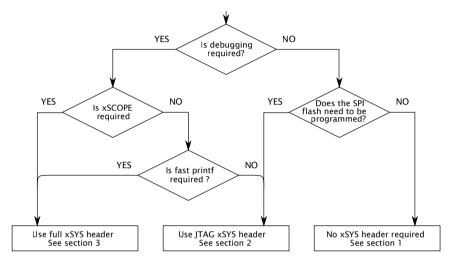


Figure 30:
Decision
diagram for
the xSYS
header

G.1 No xSYS header

The use of an xSYS header is optional, and may not be required for volume production designs. However, the XMOS toolchain expects the xSYS header; if you do not have an xSYS header then you must provide your own method for writing to flash/OTP and for debugging.

G.2 JTAG-only xSYS header

The xSYS header connects to an xTAG debugger, which has a 20-pin 0.1" female IDC header. The design will hence need a male IDC header. We advise to use a boxed header to guard against incorrect plug-ins. If you use a 90 degree angled header, make sure that pins 2, 4, 6, ..., 20 are along the edge of the PCB.

Connect pins 4, 8, 12, 16, 20 of the xSYS header to ground, and then connect:

- ▶ TDI to pin 5 of the xSYS header
- ► TMS to pin 7 of the xSYS header
- ► TCK to pin 9 of the xSYS header
- DEBUG_N to pin 11 of the xSYS header



- ▶ TDO to pin 13 of the xSYS header
- RST_N and TRST_N to pin 15 of the xSYS header
- If MODE2 is configured high, connect MODE2 to pin 3 of the xSYS header. Do not connect to VDDIO.
- If MODE3 is configured high, connect MODE3 to pin 3 of the xSYS header. Do not connect to VDDIO.

The RST_N net should be open-drain, active-low, and have a pull-up to VDDIO.

G.3 Full xSYS header

For a full xSYS header you will need to connect the pins as discussed in Section G.2, and then connect a 2-wire xCONNECT Link to the xSYS header. The links can be found in the Signal description table (Section 4): they are labelled XLA, XLB, etc in the function column. The 2-wire link comprises two inputs and outputs, labelled $\frac{1}{0}$ out, $\frac{0}{0}$, $\frac{0}{i}$, and $\frac{1}{i}$, . For example, if you choose to use XLB of tile 0 for xSCOPE I/O, you need to connect up XLB $\frac{1}{0}$ v, XLB $\frac{0}{0}$ v, XLB $\frac{1}{0}$ in as follows:

- ➤ XLB¹_{out} (X0D16) to pin 6 of the xSYS header with a 33R series resistor close to the device.
- XLB⁰_{out} (X0D17) to pin 10 of the xSYS header with a 33R series resistor close to the device.
- ► XLB_{in} (X0D18) to pin 14 of the xSYS header.
- ► XLB¹_{in} (X0D19) to pin 18 of the xSYS header.



H Schematics Design Check List

This section is a checklist for use by schematics designers using the XS1-L6A-64-TQ48. Each of the following sections contains items to check for each design.

H.1 Power supplies

| VDDIO supply is within specification (3.0V - 3.6V) before the VDD (core) supply is turned on. Specifically, the VDDIO supply is within specification before VDD (core) reaches 0.4V (Section 10). |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| The VDD (core) supply ramps monotonically (rises constantly) from 0V to its final value (0.95V - 1.05V) within 10ms (Section 10). |
| The VDD (core) supply is capable of supplying 300mA (Section 10). |
| PLL_AVDD is filtered with a low pass filter, for example An RC filter, see Section 10 |

H.2 Power supply decoupling

| П | The design has multiple decoupling capacitors per supply, for example |
|---|-----------------------------------------------------------------------|
| _ | at least four0402 or 0603 size surface mount capacitors of 100nF ir |
| | value, per supply (Section 10). |

| П | A bulk decoupling | capacitor | of at leas | t 10uF | is placed | on each | supply |
|---|-------------------|-----------|------------|--------|-----------|---------|--------|
| _ | (Section 10). | | | | | | |

H.3 Power on reset

| The RST_N and TRST_Npins are asserted (low) during or after power |
|--------------------------------------------------------------------------|
| up. The device is not used until these resets have taken place. |
| As the errata in the datasheets show, the internal pull-ups on these two |
| pins can occasionally provide stronger than normal pull-up currents |
| For this reason, an RC type reset circuit is discouraged as behavior |
| would be unpredictable. A voltage supervisor type reset device is |
| recommended to guarantee a good reset. This also has the benefit of |
| resetting the system should the relevant supply go out of specification. |

H.4 Clock

The CLK input pin is supplied with a clock with monotonic rising edges and low jitter.



| | oscillator frequency. The MODE settings are shown in the Oscillator section, Section 6. If you have a choice between two values, choose the value with the highest multiplier ratio since that will boot faster. |
|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| H.5 | USB ULPI Mode |
| This | section can be skipped if you do not have an external USB PHY. |
| | If using ULPI, the ULPI signals are connected to specific ports as shown in Section E. |
| | If using ULPI, the ports that are used internally are not connected, see Section E. (Note that this limitation only applies when the ULPI is enabled, they can still be used before or after the ULPI is being used.) |
| Н.6 | Boot |
| | The device is connected to a SPI flash for booting, connected to X0D0, X0D01, X0D10, and X0D11 (Section 7). If not, you must boot the device through OTP or JTAG. |
| | The device that is connected to flash has both MODE2 and MODE3 NC (Section 7). |
| | The SPI flash that you have chosen is supported by xflash , or you have created a specification file for it. |
| H.7 | JTAG, XScope, and debugging |
| | You have decided as to whether you need an XSYS header or not (Section $\ensuremath{\text{\textbf{G}}}\xspace)$ |
| | If you included an XSYS header, you connected pin 3 to any MODE2/MODE3 pin that would otherwise be NC (Section G). |
| | If you have not included an XSYS header, you have devised a method to program the SPI-flash or OTP (Section ${\bf G}$). |
| Н.8 | Multi device designs |
| Skip | this section if your design only includes a single XMOS device. |
| | One device is connected to a SPI flash for booting. |

Pins MODE0 and MODE1 are set to the correct value for the chosen



| Devices that boot from link have MODE2 grounded and MODE3 NOT These device must have link XLB connected to a device to boot from (see 7). | |
|-------------------------------------------------------------------------------------------------------------------------------------------|--|
| If you included an XSYS header, you have included buffers for RST_N, TRST_N, TMS. TCK, MODE2, and MODE3 (Section F). | |

I PCB Layout Design Check List

₩ This section is a checklist for use by PCB designers using the XS1-L6A-64-TQ48. Each of the following sections contains items to check for each design. I.1 Ground Plane Multiple vias (eq. 9) have been used to connect the center pad to the П PCB ground plane. These minimize impedance and conduct heat away from the device. (Section 10.2). Other than ground vias, there are no (or only a few) vias underneath П or closely around the device. This create a good, solid, ground plane. Examples of a good and bad designs are shown in Figure XXX. I.2 Power supply decoupling The decoupling capacitors are all placed close to a supply pin (Sec-tion 10). The decoupling capacitors are spaced around the device (Section 10). П The ground side of each decoupling capacitor has a direct path back to \Box the center ground the device. Examples of good and bad decoupling designs are shown in Figure XXX. I.3 PLL AVDD The PLL_AVDD filter (especially the capacitor) is placed close to the П PLL_AVDD pin (Section 10).



J Associated Design Documentation

| Document Title | Information | Document Number |
|------------------------------------------------|-------------------------------------------|-----------------|
| XS1-L Hardware Design Checklist | Board design checklist | X6277 |
| Estimating Power Consumption For XS1-L Devices | Power consumption | X4271 |
| Programming XC on XMOS Devices | Timers, ports, clocks, cores and channels | X9577 |
| xTIMEcomposer User Guide | Compilers, assembler and linker/mapper | X3766 |
| | Timing analyzer, xScope, debugger | |
| | Flash and OTP programming utilities | |

K Related Documentation

| Document Title | Information | Document Number |
|-------------------------------------------------|-------------------------------------|-----------------|
| The XMOS XS1 Architecture | ISA manual | X7879 |
| XS1 Port I/O Timing | Port timings | X5821 |
| XS1-L System Specification | Link, switch and system information | X1151 |
| XS1-L Link Performance and Design Guidelines | Link timings | X2999 |
| XS1-L Clock Frequency Control | Advanced clock control | X1433 |
| XS1-L Active Power Conservation | Low-power mode during idle | X7411 |



L Revision History

| Date | Description |
|------------|------------------------------------------------------------------|
| 2013-01-30 | New datasheet - revised part numbering |
| 2013-02-26 | New multicore microcontroller introduction |
| | Moved configuration sections to appendices |
| 2013-07-19 | Updated Features list with available ports and links - Section 2 |
| | Simplified link bits in Signal Description - Section 4 |
| | New JTAG, xSCOPE and Debugging appendix - Section G |
| | New Schematics Design Check List - Section H |
| | New PCB Layout Design Check List - Section I |



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